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# CubeSat Kit™

Pluggable Processor Module (PPM) B1  
Hardware Revision: A

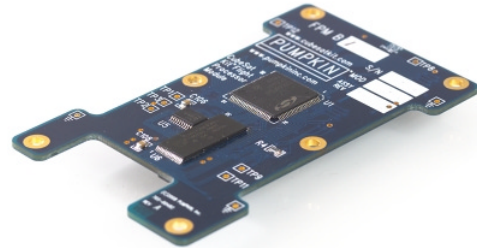
## PPM with Silicon Labs® C8051 for CubeSat Kit Motherboard

### Applications

- CubeSat nanosatellite control, C&DH, TT&C
- General-purpose low-power computing for CubeSat Kit architecture
- Remote sensing for harsh environments

### Features

- For CubeSat Kit Motherboard (MB)
- Silicon Labs® C8051F120 8-bit microcontroller (MCU)
- 128KB program memory, 8448B on-chip SRAM
- Up to 100MIPS @ 100MHz
- Integrated peripherals:
  - 2 UARTs, 1 SPI, 1 I2C
  - 8-channel 8-bit 500ksps ADC
  - 2-channel 12-bit DAC
  - 5 16-bit counter/timers
  - 6 16-bit capture/compare modules
  - 2 analog comparators
  - WDT, JTAG, BOD, etc.
- On-board fast 128KB static RAM for XRAM
- Provision for external clock crystal
- Independent latchup (device overcurrent) protection
- Independent external reset supervisor (POR/BOR)
- Large-size PPM footprint
- 4-layer gold-plated blue-soldermask PCB
- Compatible with Pumpkin's Salvo™ RTOS and HCC-Embedded's EFFS-THIN SD Card file FAT file system for ease of programming



### ORDERING INFORMATION

Pumpkin P/N 710-00487

Option Code	PPM Connector Height
/00 (standard)	+3mm

Contact factory for availability of optional configurations.  
Option code /00 shown.



### CAUTION

Electrostatic  
Sensitive  
Devices

Handle with  
Care



**CHANGELOG**

Rev.	Date	Author	Comments
A	20090728	AEK	Initial revision.
B	20090807	AEK	Added photo.

## OPERATIONAL DESCRIPTION

PPM B1 enables CubeSat Kit customers to utilize the C8051 processor on a CubeSat Kit Motherboard (MB). PPM B1 uses the 100-pin C8051F120-GQ, with a wide selection of on-chip peripherals. Additionally, a 1Mbit external static RAM is present for off-chip storage.

## ABSOLUTE MAXIMUM RATINGS

Parameter	Symbol	Value	Units
Operating temperature	$T_A$	-40 to +85	°C
Operating temperature, C8051F120 alone	$T_{A\_MCU}$	-55 to +125	°C
Voltage on +5V_USB bus		-0.3 to +6.0	V
Voltage on +5V_SYS bus			
Voltage on -FAULT_OC open-collector output			
Voltage on VCC bus		-0.3 to +3.6	V
Voltage on VCC_SD bus			
Voltage on any processor pin except VDD and port I/O		-0.3 to (VCC + 0.3)	V
Voltage on any processor VDD or port I/O pin		-0.3 to +5.8V	V
Maximum current sourced or sunk by any processor port I/O pin		100	mA
DC current through any pin of PPM connector H1	$I_{PIN\_MAX}$	1.2	A

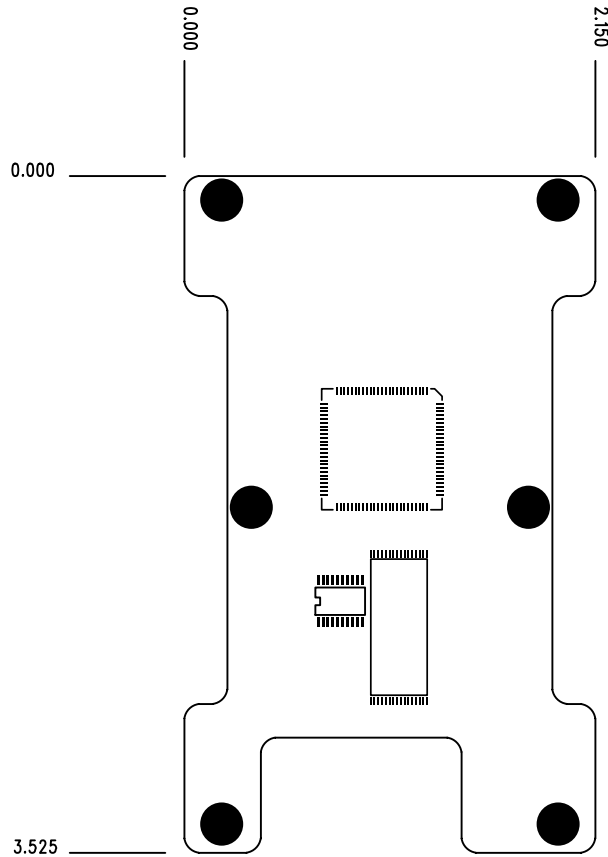
Refer to the C8-51F120/1/2/3/4/5/6/7 family datasheet for additional absolute maximum ratings associated with processor U1.

**PHYSICAL CHARACTERISTICS**

Parameter	Conditions / Notes	Symbol	Min	Typ	Max	Units
Mass				16		g
Height of components above PCB					2	mm
Height of components below PCB <sup>1</sup>					4	mm
PCB width	Medium-size PPM			54.6		mm
PCB length				89.5		mm
PCB thickness				1.6		mm

**SIMPLIFIED MECHANICAL LAYOUT <sup>2</sup>**

PPM B1 is implemented on a medium-size PPM PCB, as shown below.



<sup>1</sup> Not including connector H1.

<sup>2</sup> Dimensions in inches.

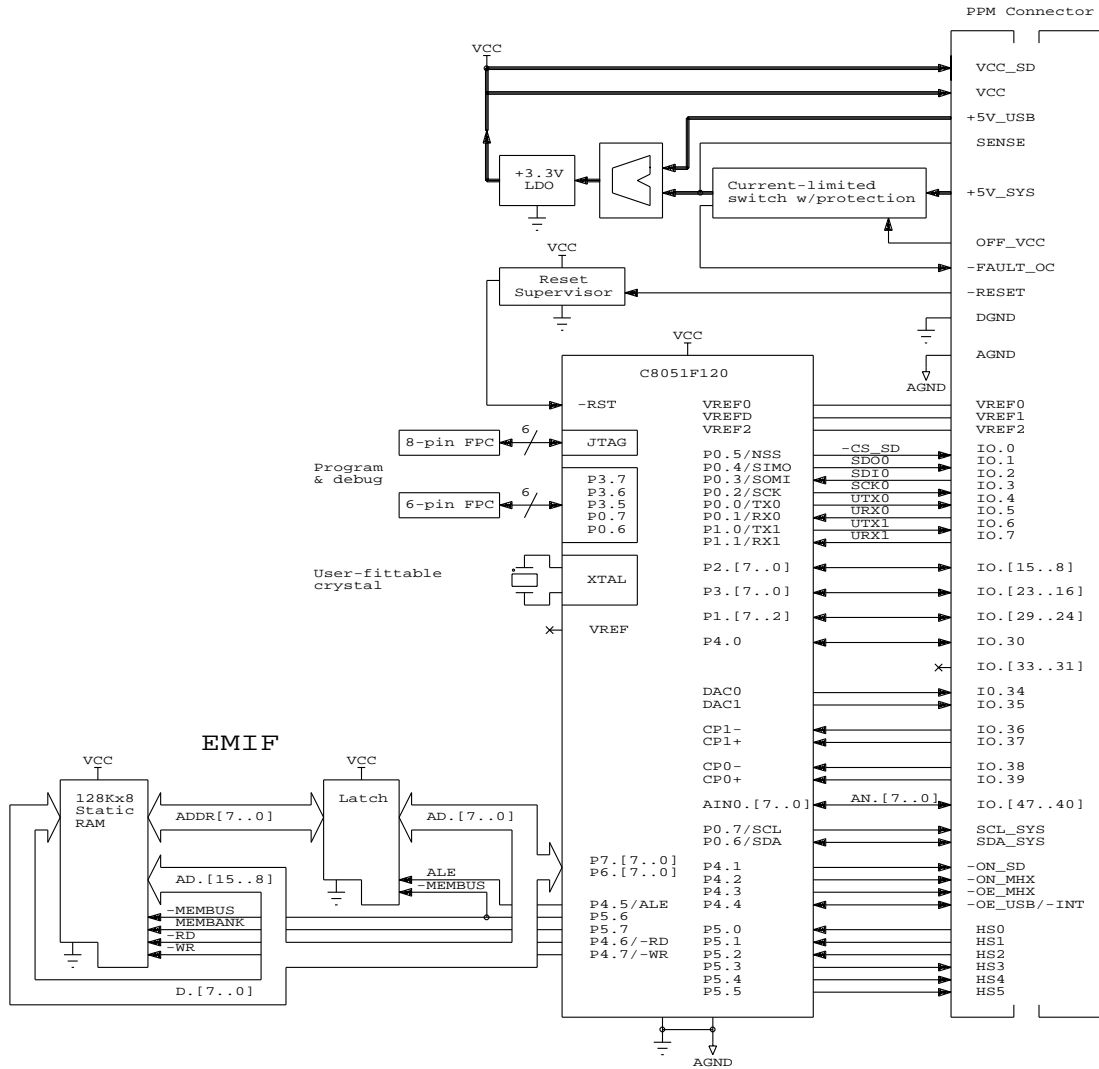
**ELECTRICAL CHARACTERISTICS**

(T = 25°C, +5V bus = +5V unless otherwise noted)

Parameter	Conditions / Notes	Symbol	Min	Typ	Max	Units
Reset voltage	+5V_SYS reduced until MCU resets	V <sub>RESET_MAX</sub>			3.1	V
Operating Voltage		V <sub>CC</sub>		3.3		V
SD Card Voltage		V <sub>CC_SD</sub>		3.3		V
Operating current	Typical operation	I <sub>OP</sub>		TBD		mA
	All control outputs inactive, PPM asleep	I <sub>SLEEP</sub>		TBD	TBD	μA
Overcurrent trip point for VCC	Set by R3	I <sub>TRIP_VCC</sub>		220		mA
Time to switch between +5V_SYS and +5V_USB power sources	Automatic				1	μs

## BLOCK DIAGRAM

PPM B1 provides regulated and current-limited +3.3V power, an external POR/BOR reset supervisor, JTAG and user interfaces for programming and debugging, a provision for an external crystal, an external high-speed<sup>3</sup> 1Mbit static RAM, connections to 45 of 48 I/O pins of the PPM connector, dedicated MB control and radio handshaking signals, a single-point analog/digital ground, and a careful assignment of the C8051 peripherals to the PPM connector and CubeSat Kit bus. One of the C8051's 100 pins is not used.



<sup>3</sup> 45ns.

## PPM PIN DESCRIPTIONS

The PPM connector H1 connects the PPM to resources residing on the MB and to resources accessible via the CubeSat Kit Bus connector.<sup>4</sup>

Those signals that are connected directly to the PPM connector and to the CubeSat Kit Bus connectors are tagged under the CSKB label below.<sup>5</sup> Signals marked with an “\*” are associated with dedicated peripherals on the MB. They may also be used with off-board peripherals through the proper use of MB peripheral enables and MB power control.

The *potential* for a pin’s function is described by the I/O field. The *recommended usage* (as a digital or analog input or output, or as a power pin) is listed in the Description field. I/O pins can generally be configured as general-purpose I/O if the recommended usage is not desired.

*Inputs* are signals *from* the MB to the PPM’s processor U1 or other circuitry. *Outputs* are signals *from* the PPM’s processor U1 or other circuitry *to* the MB.

H1			
LSS-150-01-L-DV			
IO.23	2	1	IO.47
IO.22	4	3	IO.46
IO.21	6	5	IO.45
IO.20	8	7	IO.44
IO.19	10	9	IO.43
IO.18	12	11	IO.42
IO.17	14	13	IO.41
IO.16	16	15	IO.40
IO.15	18	17	IO.39
IO.14	20	19	IO.38
IO.13	22	21	IO.37
IO.12	24	23	IO.36
IO.11	26	25	IO.35
IO.10	28	27	IO.34
IO.9	30	29	IO.33
IO.8	32	31	IO.32
IO.7	* 34	33	IO.31
IO.6	* 36	35	IO.30
IO.5	* 38	37	IO.29
IO.4	* 40	39	IO.28
IO.3	* 42	41	IO.27
IO.2	* 44	43	IO.26
IO.1	* 46	45	IO.25
IO.0	* 48	47	IO.24
+5V_USB	50	49	+5V_USB
+5V_SYS	52	51	+5V_SYS
VCC_SD	54	53	VCC_SD
VCC	56	55	VCC
DGND	58	57	DGND
AGND	60	59	AGND
VBATT	62	61	VBATT
VBACKUP	64	63	VBACKUP
VREF0	66	65	* -FAULT_OC <--
VREF1	68	67	SENSE <--
VREF2	70	69	-RESET -->
	X 72	71	OFF_VCC -->
	X 74	73	SDA_SYS <-->
	X 76	75	SCL_SYS <-->
<--	X 78	77	X
<--	X 80	79	X
--> -ON_SD	* 82	81	X
--> -ON_MHX	* 84	83	X
--> -OE_MHX	* 86	85	X
--> -OE_USB/-INT	* 88	87	X
<-- HS0	* 90	89	X
<-- HS1	* 92	91	X
<-- HS2	* 94	93	X
--> HS3	* 96	95	X
--> HS4	* 98	97	X
--> HS5	* 100	99	X

<sup>4</sup> Not included. MBs are purchased separately from PPMs.

<sup>5</sup> The CubeSat Kit’s system peripherals are numbered from 0 onwards (e.g., UART0, SPI0, etc.), and this nomenclature is used when referring to a PPM or CSK bus signal. The C8051’s peripheral nomenclature begins with 0 (e.g., UART0, SMB0, etc.), and is used when referring to peripherals, signals and registers internal to the C8051.

## PPM PIN DESCRIPTIONS – I/O

Name	Pin	I/O	CSKB	Description
IO.0	H1.48	I/O	•	-cs_sd. Controls SD Card interface. From P0.5 (U1.57). Part of the MB's SD card interface. P0.5 is normally configured as output function SPI0:NSS.
IO.1	H1.46	I/O	•	sdo0. SPI0 (master) data out. From P0.4 (U1.58). Part of the MB's SD card interface. P0.4 is normally configured as output function SPI0:MOSI.
IO.2	H1.44	I/O	•	sdi0. SPI0 (master) data in. To P0.3 (U1.59). Part of the MB's SD card interface. P0.3 is normally configured as input function SPI0:MISO.
IO.3	H1.42	I/O	•	sck0. SPI0 clock. From P0.2 (U1.60). Part of the MB's SD card interface. P0.2 is normally configured as output function SPI0:SCK.
IO.4	H1.40	I/O	•	utx0. Tx0 data out. From P0.0 (U1.62). P0.0 is normally configured as output function UART0:TX0.
IO.5	H1.38	I/O	•	urx0. Rx0 data in. To P0.1 (U1.61). P0.1 is normally configured as input function UART0:RX0.
IO.6	H1.36	I/O	•	utx1. Tx1 data out. From P1.0 (U1.36). Part of the MB's MHX/USB interface. P1.0 is normally configured as output function UART1:TX1.
IO.7	H1.34	I/O	•	urx1. Rx1 data in. To P1.1 (U1.35). Part of the MB's MHX/USB interface. P1.1 is normally configured as input function UART1:RX1.
IO.8	H1.32	I/O	•	General-purpose I/O. To/from P2.0 (U1.46).
IO.9	H1.30	I/O	•	General-purpose I/O. To/from P2.1 (U1.45).
IO.10	H1.28	I/O	•	General-purpose I/O. To/from P2.2 (U1.44).
IO.11	H1.26	I/O	•	General-purpose I/O. To/from P2.3 (U1.43).
IO.12	H1.24	I/O	•	General-purpose I/O. To/from P2.4 (U1.42).
IO.13	H1.22	I/O	•	General-purpose I/O. To/from P2.5 (U1.41).
IO.14	H1.20	I/O	•	General-purpose I/O. To/from P2.6 (U1.40).
IO.15	H1.18	I/O	•	General-purpose I/O. To/from P2.7 (U1.39).
IO.16	H1.16	I/O	•	General-purpose I/O. To/from P3.0 (U1.54).
IO.17	H1.14	I/O	•	General-purpose I/O. To/from P3.1 (U1.53).
IO.18	H1.12	I/O	•	General-purpose I/O. To/from P3.2 (U1.52).
IO.19	H1.10	I/O	•	General-purpose I/O. To/from P3.3 (U1.51).
IO.20	H1.8	I/O	•	General-purpose I/O. To/from P3.4 (U1.50).
IO.21	H1.6	I/O	•	General-purpose I/O. To/from P3.5 (U1.49).
IO.22	H1.4	I/O	•	General-purpose I/O. To/from P3.6 (U1.48).
IO.23	H1.2	I/O	•	General-purpose I/O. To/from P3.7 (U1.47).
IO.24	H1.47	I/O	•	General-purpose I/O. To/from P1.2 (U1.34).
IO.25	H1.45	I/O	•	General-purpose I/O. To/from P1.3 (U1.33).
IO.26	H1.43	I/O	•	General-purpose I/O. To/from P1.4 (U1.32).
IO.27	H1.41	I/O	•	General-purpose I/O. To/from P1.5 (U1.31).
IO.28	H1.39	I/O	•	General-purpose I/O. To/from P1.6 (U1.30).
IO.29	H1.37	I/O	•	General-purpose I/O. To/from P1.7 (U1.29).
IO.30	H1.35	I/O	•	General-purpose I/O. To/from P4.0 (U1.98).
IO.31	H1.33	I/O	•	Not connected.
IO.32	H1.31	I/O	•	Not connected.
IO.33	H1.29	I/O	•	Not connected.
IO.34	H1.27	I/O	•	DAC voltage output. From DAC0 (U1.100).
IO.35	H1.25	I/O	•	DAC voltage output. From DAC1 (U1.99).
IO.36	H1.23	I/O	•	Comparator 1 inverting input. To CP1- (U1.6).
IO.37	H1.21	I/O	•	Comparator 1 non-inverting input. To CP1+ (U1.7).



## CubeSat Kit PPM B1 Rev. A

IO.38	H1.19	I/O	•	Comparator 0 inverting input. To CP0- (U1.8).
IO.39	H1.17	I/O	•	Comparator 0 non-inverting input. To CP0+ (U1.9).
IO.40	H1.15	I/O	•	AN0. Analog input 0. To AIN0.0 (U1.18).
IO.41	H1.13	I/O	•	AN1. Analog input 1. To AIN0.1 (U1.19).
IO.42	H1.11	I/O	•	AN2. Analog input 2. To AIN0.2 (U1.20).
IO.43	H1.9	I/O	•	AN3. Analog input 3. To AIN0.3 (U1.21).
IO.44	H1.7	I/O	•	AN4. Analog input 4. To AIN0.4 (U1.22).
IO.45	H1.5	I/O	•	AN5. Analog input 5. To AIN0.5 (U1.23).
IO.46	H1.3	I/O	•	AN6. Analog input 6. To AIN0.6 (U1.24).
IO.47	H1.1	I/O	•	AN7. Analog input 7. To AIN0.7 (U1.25).

### PPM PIN DESCRIPTIONS – Power

Name	Pin	I/O	CSKB	Description
+5V_USB	H1.49 H1.50	–	•	+5V USB power. From USB host. Powers PPM.
+5V_SYS	H1.51 H1.52	–	•	+5V system power. From EPS or external +5V connector. Powers PPM.
VCC_SD	H1.53 H1.54	–		+3.3V SD Card power. From PPM's vcc.
VCC	H1.55 H1.56	–		+3.3V PPM power, MB power and I/O level. From PPM LDO U4 using +5V_SYS and/or +5V_USB.
DGND	H1.57 H1.58	–	•	Digital ground.
AGND	H1.59 H1.60	–	•	Analog ground.
VBATT	H1.61 H1.62	–	•	Not connected.
VBACKUP	H1.63 H1.64	–	•	Not connected.

### PPM PIN DESCRIPTIONS – Analog References

Name	Pin	I/O	CSKB	Description
VREF0	H1.66	–	•	ADC0 voltage reference input. To/from VREF0 (U1.16).
VREF1	H1.68	–	•	DAC voltage reference input.. To/from VREFD (U1.15).
VREF2	H1.70	–	•	ADC2 voltage reference input. To/from VREF2 (U1.17).

### PPM PIN DESCRIPTIONS – Reserved

Name	Pin	I/O	CSKB	Description
RSVD0	H1.72	–	•	Not connected. Reserved for future use.
RSVD1	H1.74	–	•	Not connected. Reserved for future use.
RSVD2	H1.76	–	•	Not connected. Reserved for future use.

### PPM PIN DESCRIPTIONS – MB-Specific

Name	Pin	I/O	CSKB	Description
CB4 USBDP	H1.78	I		Not connected.
CB2 USBDM				
-ON_SD	H1.82	O		Control signal for SD Card power. From P4.1 (U1.97). Active LOW, pulled high on the MB. When active, enables VCC_CARD on the MB, thereby powering SC Card socket and SD Card level translators / isolators. <i>Normally configured as a digital output.</i>

-ON_MHX	H1.84	O		Control signal for MHX socket power. From P4.2 (U1.96). Active LOW, pulled high on the MB. When active, enables PWR_MHX on the MB, thereby powering MHX socket and MHX level translators / isolators. <i>Normally configured as a digital output.</i>
-OE_MHX	H1.86	O		Control signal for MHX interface. From P4.3 (U1.95). Active LOW, pulled high on the MB. When active, enables signals to pass through MHX level translators / isolators. <i>Normally configured as a digital output.</i>
-OE_USB	H1.88	O		Control signal for USB interface. From P4.4 (U1.94). Active LOW, pulled high on the MB. When active, enables signals to pass through USB level translators / isolators. <i>Normally configured as a digital output.</i>
-INT		I		Output from RTC's -IRQ open-collector output. To P4.4 (U1.94). Can be used to poll MB RTC's interrupt output. <i>Normally configured as a digital input.</i>
HS0	H1.90	I		Handshake signal. -RTS (USB) or -CTS (MHX). To P5.0 (U1.88). <i>Can be configured as an external interrupt to U1 or input handshake signal via its Peripheral Pin Select. Requires that R10 be fitted on the MB.</i>
HS1	H1.92	I		Handshake signal. -DTR (USB) or -DSR (MHX). To P5.1 (U1.87). <i>Can be configured as an external interrupt to U1 or input handshake signal via its Peripheral Pin Select. Requires that R11 be fitted on the MB.</i>
HS2	H1.94	I		Handshake signal. -PWE (USB) or -DCD (MHX). To P5.2 (U1.86). <i>Can be configured as an external interrupt to U1 or input handshake signal via its Peripheral Pin Select. Requires that R12 be fitted on the MB.</i>
HS3	H1.96	O		Handshake signal. -CTS (USB) or -RTS (MHX). From P5.3 (U1.85). <i>Can be configured as an output handshake signal via its Peripheral Pin Select. Requires that R75 be fitted on the MB.</i>
HS4	H1.98	O		Handshake signal. -RI (USB) or -DTR (MHX). From P5.4 (U1.84). <i>Can be configured as an output handshake signal via its Peripheral Pin Select. Requires that R76 be fitted on the MB.</i>
HS5	H1.100	O		Handshake (reset) signal. -RST (USB) or -RST (MHX). From P5.5 (U1.83). <i>Can be configured as an output handshake signal via its Peripheral Pin Select. Requires that R77 be fitted on the MB.</i>

**PPM PIN DESCRIPTIONS – Control & Status**

Name	Pin	I/O	CSKB	Description
-FAULT_OC	H1.65	O		Open-collector output from PPM's latching prevention overcurrent switch. Active LOW. Wire-ORed to -FAULT_OC on the MB.
SENSE	H1.67	-	•	Can be used to measure PPM's current consumption. The current used by the PPM from a single source is (source – SENSE) / 75mΩ. Depends on PPM implementation.
-RESET	H1.69	I	•	Reset signal to PPM's reset supervisor. Active LOW.
OFF_VCC	H1.71	I	•	Control signal to PPM's power circuit(s). Active HIGH.

### PPM PIN DESCRIPTIONS – I2C Bus

Name	Pin	I/O	CSKB	Description
SDA_SYS	H1.73	I/O	•	I2C data. To/from P0.6 (U1.56). Part of the I2C interface. P0.6 is normally configured as an I2C data input/output. Can also be used as general-purpose I/O.
SCL_SYS	H1.75	O	•	I2C clock. From P0.7 (U1.55). Part of the I2C interface. P0.7 is normally configured as an I2C clock output. Can also be used as general-purpose I/O.

### PPM PIN DESCRIPTIONS – User-defined

Name	Pin	I/O	CSKB	Description
USER0	H1.77	I/O	•	Not connected.
USER1	H1.79	I/O	•	Not connected.
USER2	H1.81	I/O	•	Not connected.
USER3	H1.83	I/O	•	Not connected.
USER4	H1.85	I/O	•	Not connected.
USER5	H1.87	I/O	•	Not connected.
USER6	H1.89	I/O	•	Not connected.
USER7	H1.91	I/O	•	Not connected.
USER8	H1.93	I/O	•	Not connected.
USER9	H1.95	I/O	•	Not connected.
USER10	H1.97	I/O	•	Not connected.
USER11	H1.99	I/O	•	Not connected.

### XRAM INTERFACE

PPM B1 uses the C8051's External Memory Interface (EMIF) to provide an external 1Mbit (128Kx8) SRAM functioning as high-speed XRAM via a Cypress CY62128EV30 (U6).<sup>6</sup> A multiplexed interface is implemented via U5 (SN74LV3373A) and U6. The 1Mbit SRAM is split into two selectable 64Kx8 pages. To use the EMIF, it must be configured to appear on the upper GPIO ports P4-P7, -MEMBUS must be active, and the desired bank must be selected via MEMBANK. Once configured,<sup>7</sup> the XRAM is accessed via the MOVX instruction, etc. The pin assignments associated with this interface are listed below.

### PIN DESCRIPTIONS – XRAM Interface

Name	I/O	Description
-MEMBUS	O	Memory Bus Enable. From P5.6 (U1.82). To U5's -OE pin and U6's -CE1 pin. When disabled (i.e., -MEMBUS is high), XRAM is not available, and is in its lowest-power state. When enabled, XRAM is available for full-speed operations.
MEMBANK	O	Bank select. From P5.7 (U1.81). To U6's A16 pin. Selects between lower and upper 64Kx8 XRAM bank.
ALE	O	Address Latch Enable. From P4.5/ALE (U1.93). Part of U1's EMIF on P4-P7. Latches the low-order bits of the multiplexed address EMIF address bus.
-RD	O	Read strobe. From P4.6/-RD (U1.92). Part of U1's EMIF on P4-P7. To U6's -OE pin.
-WR	O	Write strobe. From P4.7/-WR (U1.91). Part of U1's EMIF on P4-P7. To U6's -WE pin.
A[15..8]M	O	Multiplexed (upper) address bits. From P6[7..0] (U1.[80..73]). Part of U1's EMIF on P4-P7. High-order address bits presented directly to U6's A[15..8].
AD[7..0]	I/O	Multiplexed (lower) address and data bits. To/from P7[7..0] (U1.[72..65]). Part of U1's EMIF on P4-P7. Low-order address bits presented directly to latch U5's D[7..0], and data bits read back from U6's IO[7..0].

<sup>6</sup> Refer to the Cypress Semiconductor CY62128EV30 datasheet for more information.

<sup>7</sup> Wait states must be properly configured in U1 prior to accessing the XRAM.

## CONNECTORS

Item	Description	Source	Part Number	Application
1	100-pin, hermaphroditic	Samtec	LSS-150-01-L-DV	PPM connector (standard, +3mm)

This connector information is provided for reference only.

## PROGRAMMING & DEBUGGING

PPM B1 provides one interface for programming and debugging – the popular and low-cost USB Debug Adapter from Silicon Devices. It provides another debugging adapter for simple user I/O. Both are implemented via Flexible Printed Circuit (FPC) connectors on the PPM.

8-pin FPC connector J1 is for the USB Debug Adapter. Via Pumpkin's JFPC-C8051 adapter, customers can connect the USB Debug Adapter with its 10-pin 2x5 0.100" pitch dual-inline headers. The JFPC-C8051 connects to PPM B1 via an 8-conductor FPC cable.

6-pin FPC connector J2 is for user debug purposes, and is compatible with 6-conductor FPC cables. Customers who wish to use the user port must fabricate their own adapter.<sup>8</sup> Its pin assignments are described below

### PIN DESCRIPTIONS – J2 User Debug Connector

Pin	I/O	Description
1	I/O	IO.23. From P3.7 (U1.47). <i>Can be used as general-purpose I/O.</i>
2	I/O	IO.22. From P3.6 (U1.48). <i>Can be used as general-purpose I/O.</i>
3	I/O	IO.21. From P3.5 (U1.49). <i>Can be used as general-purpose I/O.</i>
4	I/O	SCL_SYS. From P0.7 (U1.55). <i>Normally used for an I2C monitor. Can be used as general-purpose I/O if properly configured.</i>
5	I/O	SDA_SYS. From P0.6 (U1.46). <i>Normally used for an I2C monitor. Can be used as general-purpose I/O if properly configured.</i>
6	--	Digital ground.

## NOTES

Through the C8051's Priority Crossbar Decoder (XBAR) the user can enable digital peripherals and have them appear at certain I/O pins on U1. To be compatible with the CubeSat Kit Motherboard (MB), the UART0, SPI0 (4-wire mode), SMB0 and UART1 peripherals *must* be enabled in the XBAR. Enabling these four peripherals maps will cause their I/O to appear properly on IO.[7..0], SCL\_SYS and SDA\_SYS (i.e., on the first 10 mappable C8051 I/O pins). Users are free to enable any of the other functions available through the XBAR, mapping them to P1.2 or beyond.

N.B.: SPI0 *must* remain configured as 4-wire SPI, even if the Slave Select (NSS) functionality is not required. Configuring SPI0 for three-wire mode will map the SCL\_SYS, SDA\_SYS, TX1 and RX1 functions to the wrong pins of U1, the MB and the CubeSat Kit bus connector. Where NSS functionality is not required, P0.5 can be treated as GPIO by appropriate register configuration.

U1's VREF (Bandgap Voltage Reference Output) is left unconnected on Rev A of PPM B1. Future revisions may offer a user-fittable zero-ohm jumper from VREF to VREF0/VREF2/VREFD.

Crystal x3 is not normally fitted, as the C8051F120 has an internal precision 24.5MHz clock source and PLL. Should the customer desire a different clock source, x3 can be fitted.<sup>9</sup> Provisions for 0805-size loading caps c3 and c4 are included on the PPM B1 PCB.

<sup>8</sup> Alternatively, a Pumpkin JFPC-PIC24 programming adapter can be used, as it maps 6 FPC pins to a 6-pin 1x6 0.100" pitch single in-line header.

<sup>9</sup> E.g. ECS P/N ECS-xxx-20-5PXDN.

XRAM  $\Upsilon 6$  is not backed up by  $V_{BACKUP}$  on Rev A of PPM B1. Future revisions may power  $\Upsilon 6$  through either  $V_{CC}$  or  $V_{BACKUP}$ .

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744 Naples Street  
San Francisco, CA 94112 USA  
tel: (415) 584-6360  
fax: (415) 585-7948

web: <http://www.pumpkininc.com/>  
email: [info@pumpkininc.com](mailto:info@pumpkininc.com)

web: <http://www.cubesatkit.com/>  
email: [info@cubesatkit.com](mailto:info@cubesatkit.com)